Product Preview

Medium Power Surface Mount Products

TMOS Single P-Channel Field Effect Transistors

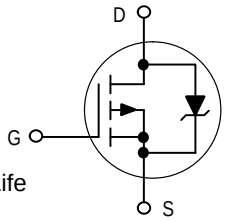
MMSF3305

Motorola Preferred Device

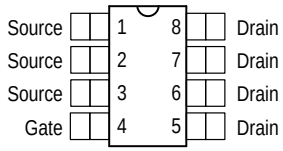
SINGLE TMOS POWER MOSFET 9.1 AMPERES 30 VOLTS $R_{DS(on)}$ = 0.02 OHM

WaveFET™ devices are an advanced series of power MOSFETs which utilize Motorola's High Cell Density HDTMOS process. These miniature surface mount MOSFETs feature ultra low $R_{DS(on)}$ and true logic level performance. They are capable of withstanding high energy in the avalanche and commutation modes and the drain–to–source diode has a very low reverse recovery time. WaveFET™ devices are designed for use in low voltage, high speed switching applications where power efficiency is important. Typical applications are dc–dc converters, and power management in portable and battery powered products such as computers, printers, cellular and cordless phones. They can also be used for low voltage motor controls in mass storage products such as disk drives and tape drives. The avalanche energy is specified to eliminate the guesswork in designs where inductive loads are switched and offer additional safety margin against unexpected voltage transients.

- Ultra Low $R_{DS(on)}$ Provides Higher Efficiency and Extends Battery Life
- Logic Level Gate Drive — Can Be Driven by Logic ICs
- Miniature SO–8 Surface Mount Package — Saves Board Space
- Diode Is Characterized for Use In Bridge Circuits
- Diode Exhibits High Speed, With Soft Recovery
- I_{DSS} Specified at Elevated Temperature
- Avalanche Energy Specified
- Mounting Information for SO–8 Package Provided



CASE 751–05, Style 13
SO–8



Top View

DEVICE MARKING **ORDERING INFORMATION**

	Device	Reel Size	Tape Width	Quantity
S3305	MMSF3305R2	13″	12 mm embossed tape	4000 units

Preferred devices are Motorola recommended choices for future use and best overall value.

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MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Negative sign for P–Channel devices omitted for clarity

Rating		Symbol	Max	Unit
Drain–to–Source Voltage		V_{DSS}	30	V
Drain–to–Gate Voltage (R_{GS} = 1.0 MΩ)		V_{DGR}	20	V
Gate–to–Source Voltage — Continuous		V_{GS}	± 20	V
1 inch SQ. FR–4 or G–10 PCB	Thermal Resistance — Junction to Ambient Total Power Dissipation @ T_A = 25°C Linear Derating Factor	R_{THJA} P_D	50 2.5 20	°C/W Watts mW/°C
10 seconds	Drain Current — Continuous @ T_A = 25°C Continuous @ T_A = 70°C Pulsed Drain Current (1)	I_D I_D I_{DM}	9.1 7.3 50	A A A
Minimum FR–4 or G–10 PCB	Thermal Resistance — Junction to Ambient Total Power Dissipation @ T_A = 25°C Linear Derating Factor	R_{THJA} P_D	80 1.56 12.5	°C/W Watts mW/°C
10 seconds	Drain Current — Continuous @ T_A = 25°C Continuous @ T_A = 70°C Pulsed Drain Current (1)	I_D I_D I_{DM}	7.2 5.8 40	A A A
Operating and Storage Temperature Range		T_J, T_{stg}	– 55 to 150	°C
Single Pulse Drain–to–Source Avalanche Energy — Starting T_J = 25°C (V_{DD} = 30 Vdc, V_{GS} = 10 Vdc, Peak I_L = 9.1 Apk, L = TBD mH, R_G = 25 Ω)		E_{AS}	TBD	mJ

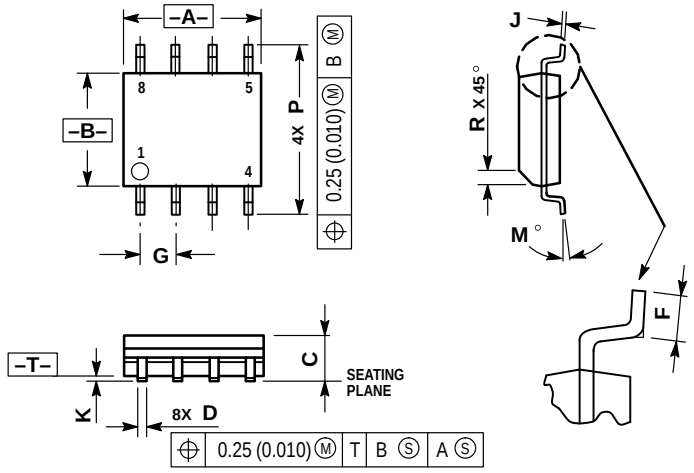
(1) Repetitive rating; pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain–to–Source Breakdown Voltage (V_{GS} = 0 Vdc, I_D = 0.25 mAdc)	(1) (3)	$V_{(BR)DSS}$	30	—	—	Vdc
Temperature Coefficient (Positive)			—	—	—	mV/°C
Zero Gate Voltage Drain Current		I_{DSS}				μAdc
(V_{DS} = 30 Vdc, V_{GS} = 0 Vdc)			—	—	1.0	
(V_{DS} = 15 Vdc, V_{GS} = 0 Vdc, T_J = 70°C)			—	—	5.0	
Gate–Body Leakage Current (V_{GS} = ± 20 Vdc, V_{DS} = 0)		I_{GSS}	—	—	100	nAdc
ON CHARACTERISTICS(1)						
Gate Threshold Voltage (V_{DS} = V_{GS}, I_D = 0.25 mAdc)	(1) (3)	$V_{GS(th)}$	0.7	—	1.4	Vdc
Threshold Temperature Coefficient (Negative)			—	—	—	mV/°C
Static Drain–to–Source On–Resistance	(1) (3)	$R_{DS(on)}$				mΩ
(V_{GS} = 10 Vdc, I_D = 9.1 Adc)			—	—	20	
(V_{GS} = 4.5 Vdc, I_D = 7.3 Adc)			—	—	30	
On–State Drain Current		$I_{D(on)}$				A
(V_{DS} ≤ 5.0 V, V_{GS} = 10 V)			40	—	—	
(V_{DS} ≤ 5.0 V, V_{GS} = 4.5 V)			10	—	—	
Forward Transconductance (V_{DS} = 15 Vdc, I_D = 8.0 Adc)	(1)	g_{FS}	—	—	—	Mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance	(V_{DS} = 30 Vdc, V_{GS} = 0 Vdc, f = 1.0 MHz)	C_{iss}	—	—	TBD	pF
Output Capacitance		C_{oss}	—	—	TBD	
Transfer Capacitance		C_{rss}	—	—	TBD	
SWITCHING CHARACTERISTICS(2)						
Turn–On Delay Time	(V_{DD} = 15 Vdc, I_D = 1.0 Adc, V_{GS} = 10 Vdc, R_G = 6.0 Ω) (1)	$t_{d(on)}$	—	—	TBD	ns
Rise Time		t_r	—	—	TBD	
Turn–Off Delay Time		$t_{d(off)}$	—	—	TBD	
Fall Time		t_f	—	—	TBD	
Gate Charge See Figure 8	(V_{DS} = 15 Vdc, I_D = 4.6 Adc, V_{GS} = 10 Vdc) (1)	Q_T	—	—	TBD	nC
		Q_1	—	—	—	
		Q_2	—	—	—	
		Q_3	—	—	—	
SOURCE–DRAIN DIODE CHARACTERISTICS						
Forward On–Voltage(1)	(I_S = 2.1 Adc, V_{GS} = 0 Vdc) (1)	V_{SD}	—	—	1.2	Vdc
	(I_S = 2.1 Adc, V_{GS} = 0 Vdc, T_J = 125°C)		—	—	—	
Reverse Recovery Time See Figure 15	(I_S = 2.1 Adc, V_{GS} = 0 Vdc, dI_S/dt = 100 A/μs) (1)	t_{rr}	—	—	TBD	ns
		t_a	—	—	—	
		t_b	—	—	—	
Reverse Recovery Stored Charge		Q_{RR}	—	—	—	μC

(1) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
(2) Switching characteristics are independent of operating junction temperature.
(3) Reflects typical values. $C_{pk} = \left| \frac{\text{Max limit – Typ}}{3 \times \text{SIGMA}} \right|$
(4) Repetitive rating; pulse width limited by maximum junction temperature.

PACKAGE DIMENSIONS



NOTES:
1. DIMENSIONS A AND B ARE DATUMS AND T IS A DATUM SURFACE.
2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
3. DIMENSIONS ARE IN MILLIMETER.
4. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
6. DIMENSION D DOES NOT INCLUDE MOLD PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS	
DIM	MIN	MAX
A	4.80	5.00
B	3.80	4.00
C	1.35	1.75
D	0.35	0.49
F	0.40	1.25
G	1.27 BSC	
J	0.18	0.25
K	0.10	0.25
M	0°	7°
P	5.80	6.20
R	0.25	0.50

STYLE 13:
PIN 1. SOURCE
2. SOURCE
3. SOURCE
4. GATE
5. DRAIN
6. DRAIN
7. DRAIN
8. DRAIN

CASE 751–05
SO–8
ISSUE P

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